Reversible sodium metal plating/stripping in a fluorine-free electrolyte

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Alkaline metals are gathering much attention as a high-capacity negative electrode for high-energy-density rechargeable batteries. However, their poor reversibility and dendritic growth have long been a barrier to practical application. Generally, an electrolyte solution is an important factor that dominates the reversibility of alkaline metal electrodes; in particular, fluorine is considered to be one of the essential elements to form a fluorine-containing protective layer that stabilizes the electrode/electrolyte interphase^{1,2}. Fluorinated salts/solvents, however, are not suitable from the view point of green chemistry. Hence, a new class of fluorine-free electrolyte for alkaline metals is needed.

Herein, we report a fluorine-free electrolyte using sodium tetraphenylborate (NaBPh₄) and 1,2-dimethoxyethane (DME). The BPh₄ anion is supposed to be stable, because the active boron atom is surrounded by four stable phenyl groups. Figure 1 shows the coulombic efficiencies of sodium metal plating/stripping in 0.1 M NaBPh₄ / DME or 1.0 M NaPF₆ / EC/DEC electrolyte. In the NaBPh₄ electrolyte, the coulombic efficiency rapidly reached 99.9 %, which was significantly higher than in the NaPF₆ / EC/DEC electrolyte. The excellent reversibility was kept over 300 cycles. The SEM image (the inset in Fig. 1) shows that the sodium metal plated in the NaBPh₄ electrolyte was non-dendritic, round shape. These results indicate better compatibility of this electrolyte with a sodium metal negative electrode. This work suggests that fluorine is not an element of definite necessity to stabilize alkaline metal negative electrolytes.



Figure 1. Coulombic Efficiencies of sodium metal plating/stripping on Cu foil in NaBPh₄/DME and conventional electrolyte obataiend by the garvanostatic measurement of Cu/Na cells at 0.5 mA cm⁻². A certain amount of sodium metal corresponding to 0.5 mAh cm⁻² was plated and then stripped to the cutoff voltage of 0.5 V. The inset shows the SEM image of sodium metal plated in the NaBPh₄ electrolyte.

References:

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